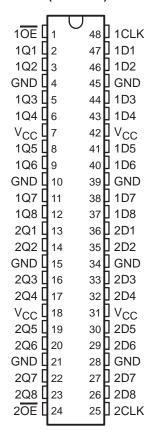
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- Members of the Texas Instruments Widebus™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V<sub>OLP</sub> (Output Ground Bounce)
   < 0.8 V at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C
- Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (-32-mA I<sub>OH</sub>, 64-mA I<sub>OL</sub>)
- Packaged in Plastic 300-mil Shrink Small-Outline Packages (DL) and 380-mil Fine-Pitch Ceramic Flat Packages (WD) Using 25-mil Center-to-Center Spacings

#### description

The 'ABT16374 is a 16-bit edge-triggered D-type flip-flop with 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. It is particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

SN54ABT16374...WD PACKAGE SN74ABT16374...DL PACKAGE (TOP VIEW)



The device can be used as two 8-bit flip-flops or one 16-bit flip-flop. On the positive transition of the clock (CLK) input, the Q outputs of the flip-flop take on the logic levels set up at the data (D) inputs.

A buffered output-enable  $(\overline{OE})$  input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without need for interface or pullup components

The output enable  $(\overline{OE})$  does not affect internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74ABT16374 is packaged in TI's shrink small-outline package (DL), which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN54ABT16374 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C. The SN74ABT16374 is characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C.

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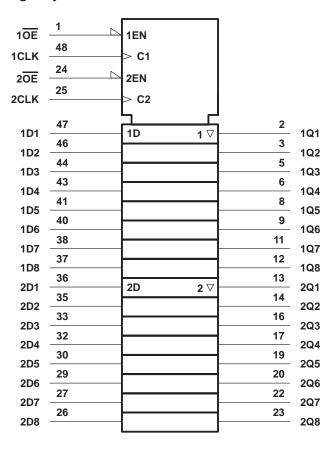


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## FUNCTION TABLE (each flip-flop)

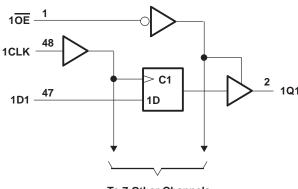
	INPUTS		OUTPUT
OE	CLK	D	Q
L	1	Н	Н
L	$\uparrow$	L	L
L	H or L	Χ	Q <sub>0</sub>
Н	Χ	Χ	Z

## logic symbol†

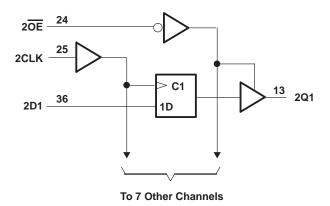


## <sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

#### logic diagram (positive logic)



To 7 Other Channels



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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	
Input voltage range, V <sub>I</sub> (see Note 1)	0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, VO	$\dots$ -0.5 V to 5.5 V
Current into any output in the low state, IO: SN54ABT16374	96 mA
SN74ABT16374	128 mA
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	–18 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)	50 mA
Maximum power dissipation at T <sub>A</sub> = 55°C (in still air)	0.85 W
Storage temperature range	65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions (see Note 2)

			SN54AB	T16374	SN74AB	T16374	
			MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage		4.5	5.5	4.5	5.5	V
VIH	High-level input voltage				2		V
$V_{IL}$	Low-level input voltage					0.8	V
٧ <sub>I</sub>	Input voltage		0,4	Vcc	0	VCC	V
loh	High-level output current		Ö	-24		-32	mA
lOL	Low-level output current		900	48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled	Q'	10		10	ns/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 2: Unused or floating inputs must be held high or low.



NOTE 1: The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

				T <sub>A</sub> = 25°C			SN54ABT16374		SN74ABT16374		
PARAMETER	TE	ST CONDITIO	NS	MIN	TYP†	MAX	MIN	MAX	MIN	MAX	UNIT
VIK	V <sub>CC</sub> = 4.5 V,	5 V, I <sub>I</sub> = -18 mA				-1.2		-1.2		-1.2	V
	$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -3 \text{ m/s}$	4	2.5			2.5		2.5		
	V <sub>CC</sub> = 5 V, I <sub>OH</sub> = -3 mA V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = -24 mA		4	3			3		3		V
VOH			Α	2			2				V
	$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -32 \text{ m}$	nA	2‡					2		
V	$V_{CC} = 4.5 \text{ V}, \qquad I_{OL} = 48 \text{ mA}$				0.55		0.55			V	
VOL	$V_{CC} = 4.5 \text{ V},$	$I_{OC} = 4.5 \text{ V}, \qquad I_{OL} = 64 \text{ mA}$				0.55‡				0.55	V
II	$V_{CC} = 5.5 \text{ V},$	$V_I = V_{CC}$ or GND				±1		£1		±1	μΑ
lozh	$V_{CC} = 5.5 \text{ V}, \qquad V_{O} = 2.7 \text{ V}$				50		50		50	μΑ	
lozL	$V_{CC} = 5.5 \text{ V}, \qquad V_{O} = 0.5 \text{ V}$				-50	, 4	-50		-50	μΑ	
loff	$V_{CC} = 0$ ,	$V_I$ or $V_O \le 4$ .	5 V			±100	(0)			±100	μΑ
ICEX	$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 5.5 V	Outputs high			50	Pac	50		50	μΑ
ΙΟ§	$V_{CC} = 5.5 \text{ V},$	$V_0 = 2.5 \text{ V}$		-50	-100	-180	<b>5</b> 0	-180	-50	-180	mA
	.,,		Outputs high			2		2		2	
Icc	$V_{CC} = 5.5 \text{ V},$ $V_{I} = V_{CC} \text{ or GND}$	$I_{O} = 0,$	Outputs low			67		67		67	mA
	V1 = VCC 01 014B		Outputs disabled			2		2		2	
ΔICC¶	$V_{CC}$ = 5.5 V, One input at 3.4 V, Other inputs at $V_{CC}$ or GND					1.5		1.5		1.5	mA
Ci	V <sub>I</sub> = 2.5 V or 0.5 V				3.5					·	pF
Co	V <sub>O</sub> = 2.5 V or 0.5 \	/			9.5						pF

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ .

# timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

		$V_{CC} = 5 \text{ V},$ $T_A = 25^{\circ}C$		SN54ABT16374		SN74ABT16374		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
fclock	Clock frequency	0	150	0,0	150	0	150	MHz
t <sub>W</sub>	Pulse duration, CLK high or low	3.3		3.3	14	3.3		ns
t <sub>su</sub>	Setup time, data before CLK↑	1.1		4:14	3	1.1		ns
th	Hold time, data after CLK↑	1.3		1.3		1.3		ns

<sup>‡</sup> On products compliant to MIL-STD-883, Class B, this parameter does not apply.

<sup>§</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

<sup>¶</sup> This is the increase in supply current for each input that is at the specified TTL voltage level rather than VCC or GND.

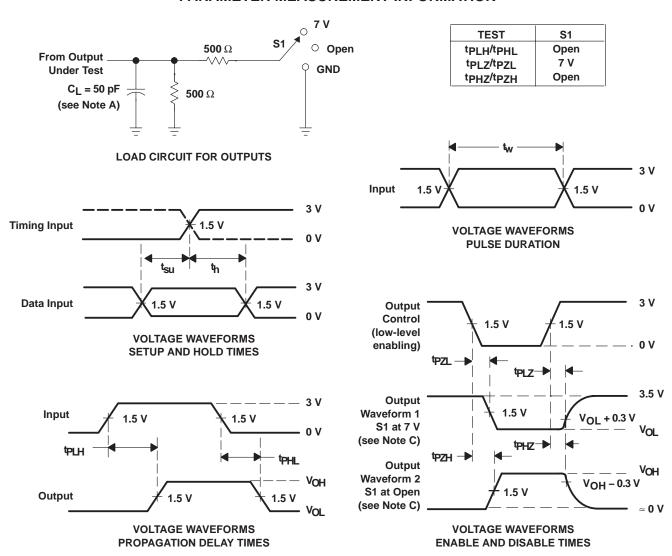
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# switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	TO (OUTPUT)	V <sub>(</sub>	CC = 5 V A = 25°C	/, ;	SN54AB1	16374	SN74AB	Г16374	UNIT
	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f <sub>max</sub>			150			150		150		MHz
t <sub>PLH</sub>	0114	_	1.8	4.3	5.4	1.8	6.4	1.8	6.2	
t <sub>PHL</sub>	CLK	Q	2.7	4.5	5.6	2.7	6.4	2.7	5.9	ns
tPZH	<del>OE</del>	_	1.4	3.6	4.8	1.4	6.1	1.4	5.7	
tPZL	OE	Q	1.7	3.5	4.6	1.7	5.5	1.7	5.3	ns
t <sub>PHZ</sub>	<del>OE</del>	Q	2.2	5.4	8.4	2.2	11	2.2	10	ns
tPLZ		l Q	2.3	4.6	7.7	2.3	9.8	2.3	8.7	115

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#### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_0 = 50 \Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





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#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74ABT16374DGGR	OBSOLETE	TSSOP	DGG	48	TBD	Call TI	Call TI
SN74ABT16374DL	OBSOLETE	SSOP	DL	48	TBD	Call TI	Call TI
SN74ABT16374DL	OBSOLETE	SSOP	DL	48	TBD	Call TI	Call TI
SN74ABT16374DLR	OBSOLETE	SSOP	DL	48	TBD	Call TI	Call TI
SN74ABT16374DLR	OBSOLETE	SSOP	DL	48	TBD	Call TI	Call TI

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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